



#### DISCRIPTION

### **FEATURES**

Molded construction Heat Resistance Molded Resin Excellent Mechanical Strength Excellent Solderability High Reliability Low Profile

# **OPTIONS**

Tape & Reel is Standard (Qty: 2000 Pcs) Bulk Packing Available for smaller quantites Tolerance: J = 5% and K=10% is Standard, tighter Tolerance available (MOQ on request)

#### **APPLICATIONS**

VCRs DC/DC Converts Video Cameras CTV, VCR HIC Communication System Automotive Systems LCD/PDP Televisions Hard Disk Drives Network Systems Computer Peripheral Equipment

#### **PHYSICAL CHARACTERISTICS**

- Testing : ( Equivalents acceptable ) Inductance : HP4285A RDC : QuadTech 1880 m $\Omega$  Q : HP4342A SRF : HP4291A
- IDC Max : Determined when superimosed DC current is decreased 10% against it's initial value
- Operating Temperature : -25°C ~ +85°C
- Storage Temperature : -40°C ~ +85°C
- Solder methods : Wave, Vapor Phase, Infrared
- Resistance to soldering heat : 260°C for 10 seconds
- Solvent resistance : Conforms to MIL-STD-202E
- Marking : Inductance & Tolercane

## **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	120	μH	see Site 2
Q factor		Q	20		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	10	Ω	max.
Self-Res. Freq.		SRF	11	Mhz	min.
Test-Freq.			0,796	Mhz	
Rated Current		IDC	70	mA	max.
Saturation Current		Isat		mA	typ.

. This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, bublic information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon					SMT WOUND MOLDED CHIP INDUCTORS			
	must be informed					Part No.:	S14	4002-121
performed on each electronic components used in electrical circuits that require high safety and reliability functions.						Customer:		
DRW:	Chang	CHKD	Young	MATL:	Chu Chi	DATE		09.06.2009
APPD:	Pong			FINISH	Vienna	Sheet		1 from 2

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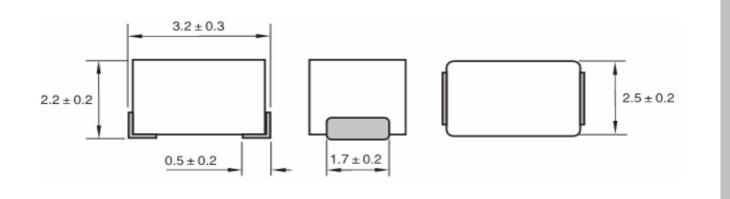
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#### **TECHNICAL INFORMATIONS**

#### Dimensions (mm)

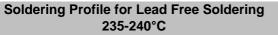


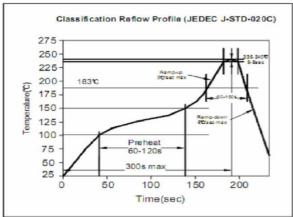
#### **Ordering Information**

Serie and Range

S14002-121

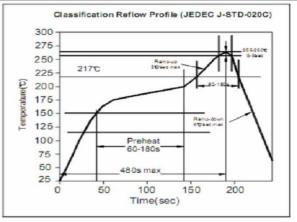
Tolerance	ROHS	Packing		
ĸ	R	TR		
1 50/				
<b>J</b> = 5%	<b>R =</b> ROHS	<b>BU =</b> Bulk Ware		
<b>K</b> = 10%	N = non ROHS	TR = Tape Reel		
<b>M</b> = 20%				
<b>N</b> = 30%				





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Soldering Profile for Lead Free Soldering 255-260°C



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-Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability					Part No.:	S14002-121		
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